

STP80N70F4

N-channel 68 V, 8.2 mΩ 85 A TO-220 STripFET™ DeepGATE™ Power MOSFET

Preliminary data

Features

Order code	V _{DSS}	R _{DS(on)} max	I _D
STP80N70F4	68 V	$<$ 9.8 m Ω	85 A

- N-channel enhancement mode
- 100% avalanched rated
- Low gate charge
- Very low on-resistance

Application

Switching applications

Description

This STripFET™ DeepGATE™ Power MOSFET technology is among the latest improvements, which have been especially tailored to minimize on-state resistance, with a new gate structure, providing superior switching performances.

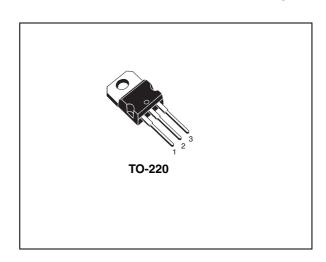


Figure 1. Internal schematic diagram

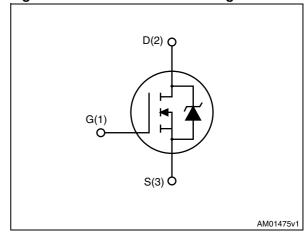


Table 1. Device summary

Order code	Marking	Package	Packaging
STP80N70F4	80N70F4	TO-220	Tube

Electrical ratings STP80N70F4

1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{DS}	Drain-source voltage (V _{GS} = 0)	68	V
V _{GS}	Gate-source voltage	± 20	V
I _D	Drain current (continuous) at T _C = 25 °C	85	Α
I _D	Drain current (continuous) at T _C = 100 °C	60	Α
I _{DM} ⁽¹⁾	Drain current (pulsed)	340	Α
P _{TOT}	Total dissipation at T _C = 25 °C	150	W
	Derating factor	1	W/°C
E _{AS} (2)	Single pulse avalanche energy	185	mJ
T _{stg}	Storage temperature	- 55 to 175	
T _j	Operating junction temperature	- 55 (0 175	

^{1.} Pulse width limited by safe operating area

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R _{thj-case}	Thermal resistance junction-case max	1	°C/W
R _{thj-a}	Thermal resistance junction-ambient max	62.5	°C/W
T _I	Maximum lead temperature for soldering purpose	300	°C

^{2.} Starting T_i = 25 °C, I_D = 35 A, V_{DD} = 34 V

2 Electrical characteristics

 $(T_{CASE} = 25 \, ^{\circ}C \text{ unless otherwise specified})$

Table 4. On/off states

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V _{(BR)DSS}	Drain-source Breakdown voltage	$I_D = 250 \ \mu A, \ V_{GS} = 0$	68			V
1	Zero gate voltage	V _{DS} = max rating			1	μΑ
DSS	Drain current (V _{GS} = 0)	V _{DS} = max rating,T _C =125 °C			100	μΑ
I _{GSS}	Gate-body leakage current (V _{DS} = 0)	V _{GS} = ± 20 V			100	nA
V _{GS(th)}	Gate threshold voltage	$V_{DS} = V_{GS}, I_{D} = 250 \mu A$	2		4	V
R _{DS(on)}	Static drain-source on resistance	V _{GS} = 10 V, I _D = 40 A		8.2	9.8	mΩ

Table 5. Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
C _{iss}	Input capacitance			5015		pF
C _{oss}	Output capacitance	$V_{DS} = 25 \text{ V, f} = 1 \text{ MHz,}$	-	382	-	pF
C _{rss}	Reverse transfer capacitance	$V_{GS} = 0$		218		pF
Qg	Total gate charge	V _{DD} = 37.5 V, I _D = 78 A,		76		nC
Q_{gs}	Gate-source charge	V _{GS} = 10 V	-	23	-	nC
Q_{gd}	Gate-drain charge	(see Figure 3)		18.5		nC

Table 6. Switching times

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t _{d(on)}	Turn-on delay time Rise time	$V_{DD} = 37.5 \text{ V}, I_{D} = 39 \text{ A}$ $R_{G} = 4.7 \Omega V_{GS} = 10 \text{ V}$	-	25 33	-	ns ns
t _{d(off)}	Turn-off-delay time Fall time	(see Figure 2)	-	61 14	-	ns ns

Electrical characteristics STP80N70F4

Table 7. Source drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max	Unit
I _{SD}	Source-drain current		-		85	Α
I _{SDM} ⁽¹⁾	Source-drain current (pulsed)		-		340	Α
V _{SD} ⁽²⁾	Forward on voltage	$I_{SD} = 78 \text{ A}, V_{GS} = 0$	-		1.5	V
t _{rr} Q _{rr} I _{RRM}	Reverse recovery time Reverse recovery charge Reverse recovery current	$I_{SD} = 78 \text{ A}, V_{DD} = 60 \text{ V}$ di/dt = 100 A/ μ s, $T_j = 150 \text{ °C}$ (see Figure 4)	-	67 183 5.5		ns nC A

^{1.} Pulse width limited by safe operating area.

^{2.} Pulsed: Pulse duration = 300 μ s, duty cycle 1.5%

STP80N70F4 Test circuits

3 Test circuits

Figure 2. Switching times test circuit for resistive load

Figure 3. Gate charge test circuit

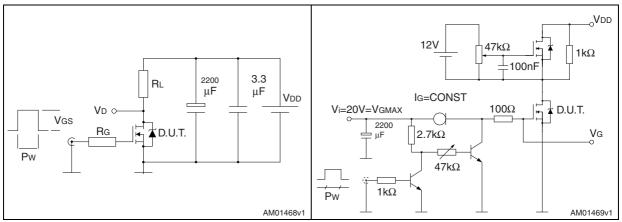


Figure 4. Test circuit for inductive load switching and diode recovery times

Figure 5. Unclamped inductive load test circuit

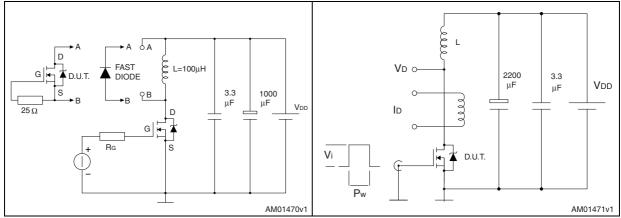
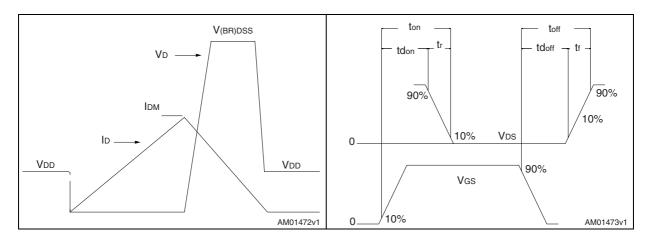


Figure 6. Unclamped inductive waveform

Figure 7. Switching time waveform



4 Package mechanical data

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com. ECOPACK is an ST trademark.

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Table 8. TO-220 type A mechanical data

	TO-220 type A meenamea		
Dim.		mm	
Diiii.	Min.	Тур.	Max.
Α	4.40		4.60
b	0.61		0.88
b1	1.14		1.70
С	0.48		0.70
D	15.25		15.75
D1		1.27	
Е	10		10.40
е	2.40		2.70
e1	4.95		5.15
F	1.23		1.32
H1	6.20		6.60
J1	2.40		2.72
L	13		14
L1	3.50		3.93
L20		16.40	
L30		28.90	
ØP	3.75		3.85
Q	2.65		2.95

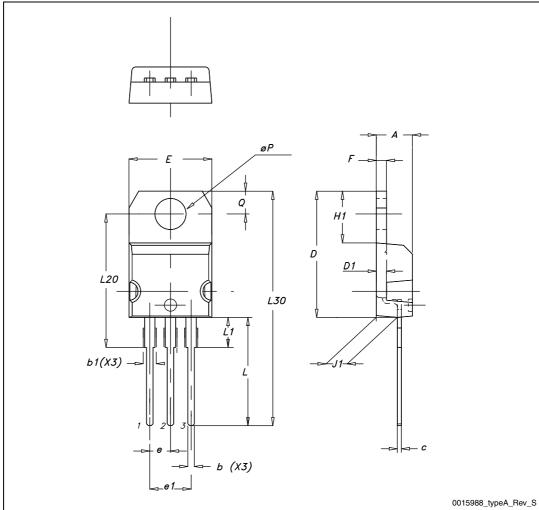


Figure 8. TO-220 type A drawing

STP80N70F4 Revision history

5 Revision history

Table 9. Document revision history

Date	Revision	Changes
12-Jan-2011	1	First release.

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